

SEMiX353GD126HDc



SEMiX[®] 33c

Trench IGBT Modules

SEMiX353GD126HDc

Features

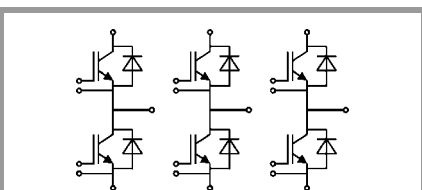
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperatur limited to $T_C=125^\circ\text{C}$ max.
- Not for new design



GD

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
IGBT				
V_{CES}			1200	V
I_C	$T_j = 150^\circ\text{C}$	$T_c = 25^\circ\text{C}$	364	A
		$T_c = 80^\circ\text{C}$	256	A
I_{Cnom}			225	A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$		450	A
V_{GES}			-20 ... 20	V
t_{psc}	$V_{CC} = 600\text{ V}$ $V_{GE} \leq 20\text{ V}$ $V_{CES} \leq 1200\text{ V}$	$T_j = 125^\circ\text{C}$	10	μs
T_j			-40 ... 150	$^\circ\text{C}$
Inverse diode				
I_F	$T_j = 150^\circ\text{C}$	$T_c = 25^\circ\text{C}$	329	A
		$T_c = 80^\circ\text{C}$	228	A
I_{Fnom}			225	A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$		450	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$		1700	A
T_j			-40 ... 150	$^\circ\text{C}$
Module				
$I_{t(RMS)}$			600	A
T_{stg}			-40 ... 125	$^\circ\text{C}$
V_{isol}	AC sinus 50Hz, $t = 1\text{ min}$		4000	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
$V_{CE(sat)}$	$I_C = 225\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.7	2.1		V
		$T_j = 125^\circ\text{C}$	2	2.45		V
V_{CE0}						
	$T_j = 25^\circ\text{C}$		1	1.2		V
	$T_j = 125^\circ\text{C}$		0.9	1.1		V
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25^\circ\text{C}$	3.1	4.0		$\text{m}\Omega$
		$T_j = 125^\circ\text{C}$	4.9	6.0		$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C = 9\text{ mA}$		5	5.8	6.5	V
I_{CES}	$V_{GE} = 0\text{ V}$ $V_{CE} = 1200\text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3		mA
		$T_j = 125^\circ\text{C}$				mA
C_{ies}				16.0		nF
C_{oes}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$		0.84		nF
C_{res}		$f = 1\text{ MHz}$		0.73		nF
Q_G	$V_{GE} = -8\text{ V...} + 15\text{ V}$			1800		nC
R_{Gint}	$T_j = 25^\circ\text{C}$			3.33		Ω
$t_{d(on)}$	$V_{CC} = 600\text{ V}$ $I_C = 225\text{ A}$	$T_j = 125^\circ\text{C}$		265		ns
t_r		$T_j = 125^\circ\text{C}$		55		ns
E_{on}	$R_{Gon} = 2\ \Omega$			26.5		mJ
$t_{d(off)}$	$R_{Goff} = 2\ \Omega$			585		ns
t_f				120		ns
E_{off}				32.5		mJ
$R_{th(j-c)}$	per IGBT				0.1	K/W

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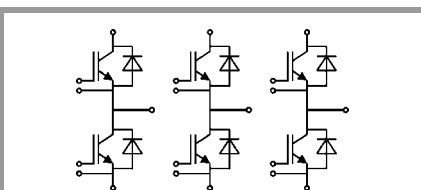
Typical Applications*

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- UPS
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Remarks

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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	$I_F = 225\text{ A}$ $V_{GE} = 0\text{ V}$ chip	$T_j = 25\text{ }^\circ\text{C}$		1.6	1.80	V
		$T_j = 125\text{ }^\circ\text{C}$		1.6	1.8	V
V_{F0}		$T_j = 25\text{ }^\circ\text{C}$	0.9	1	1.1	V
		$T_j = 125\text{ }^\circ\text{C}$	0.7	0.8	0.9	V
r_F		$T_j = 25\text{ }^\circ\text{C}$	2.2	2.7	3.1	m Ω
		$T_j = 125\text{ }^\circ\text{C}$	3.1	3.6	4.0	m Ω
I_{RRM}	$I_F = 225\text{ A}$	$T_j = 125\text{ }^\circ\text{C}$		330		A
Q_{rr}	$di/dt_{off} = 5600\text{ A}/\mu\text{s}$	$T_j = 125\text{ }^\circ\text{C}$		69		μC
E_{rr}	$V_{GE} = -15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 125\text{ }^\circ\text{C}$		29		mJ
$R_{th(j-c)}$	per diode				0.17	K/W
Module						
L_{CE}				20		nH
$R_{CC'+EE'}$	res., terminal-chip	$T_C = 25\text{ }^\circ\text{C}$		0.7		m Ω
		$T_C = 125\text{ }^\circ\text{C}$		1		m Ω
$R_{th(c-s)}$	per module			0.014		K/W
M_s	to heat sink (M5)		3		5	Nm
M_t		to terminals (M6)	2.5		5	Nm
						Nm
w					900	g
Temperatur Sensor						
R_{100}	$T_C=100^\circ\text{C}$ ($R_{25}=5\text{ k}\Omega$)			$493 \pm 5\%$		Ω
$B_{100/125}$	$R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; $T[\text{K}]$;			3550 $\pm 2\%$		K



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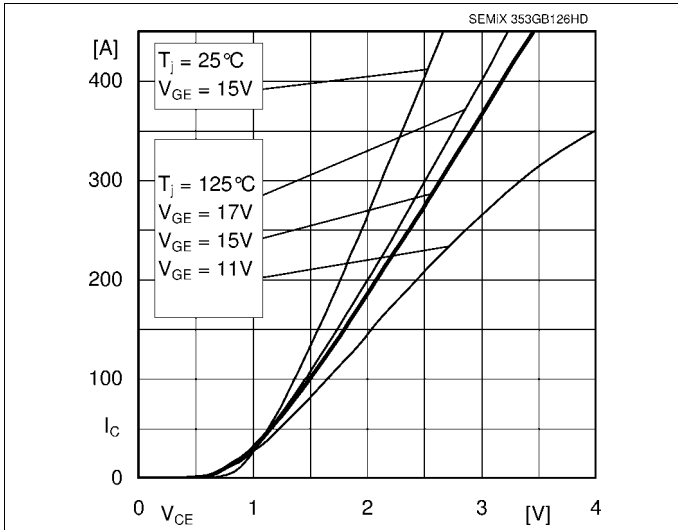


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

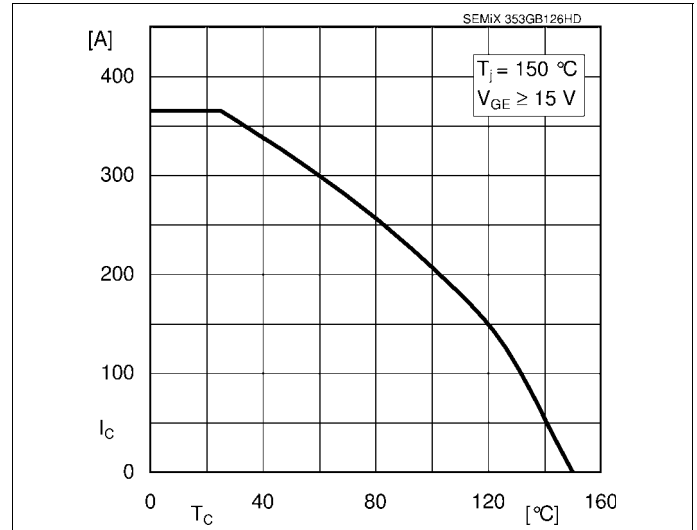


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

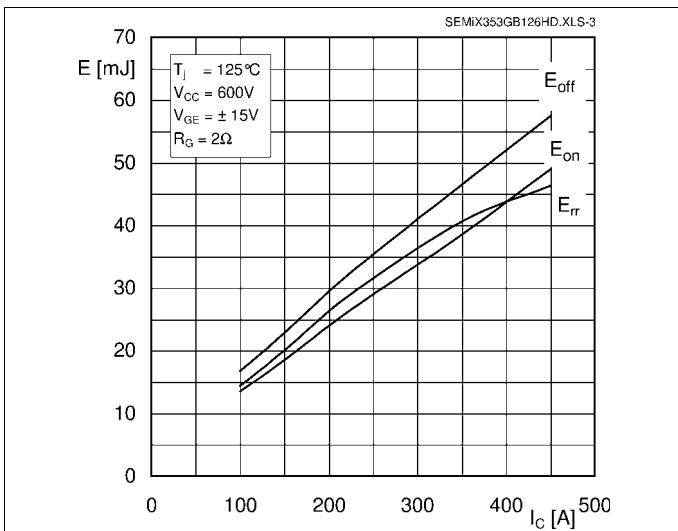


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

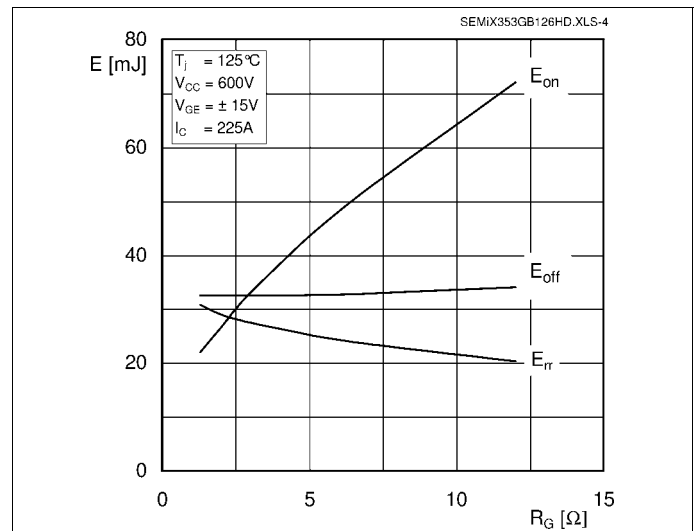


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

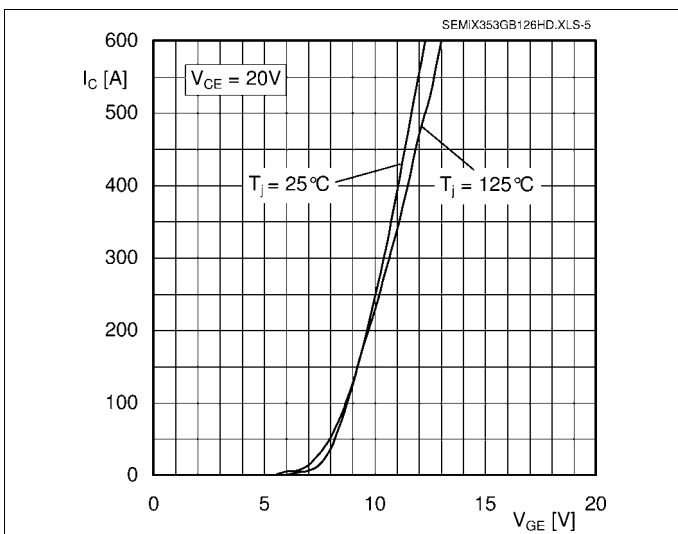


Fig. 5: Typ. transfer characteristic

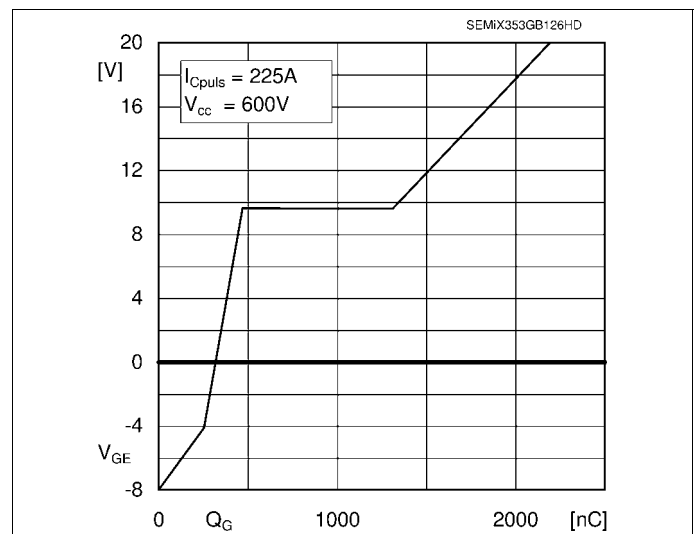


Fig. 6: Typ. gate charge characteristic

